

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	§	
Yau, et al.	§	
	§	Group Art Unit: 2823
Serial No.: 10/756,122	§	
	§	
Confirmation No.: 4554	§	
	§	Examiner: Julio J. Maldonado
Filed: January 13, 2004	§	
	§	
For: A Low Dielectric Constant	§	
Film Produced From Silicon	§	
Compounds Comprising	§	
Silicon-Carbon Bond	§	

MAIL STOP AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

RESPONSE TO OFFICE ACTION DATED MAY 12, 2006

In response to the Office Action dated May 12, 2006, having a shortened statutory period for response set to expire on August 12, 2006, please enter this response and reconsider the claims pending in the application for at least the reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/002592.C7/KMT for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

The Pending Claims are listed beginning on page 2 of this paper. **Remarks** begin on page 5 of this paper.